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# HD74HC374, HD74HC534

Octal D-type Flip-Flops (with 3-state outputs)
Octal D-type Flip-Flops (with inverted 3-state outputs)

REJ03D0620-0200 (Previous ADE-205-499) Rev.2.00 Mar 30, 2006

#### **Description**

These devices are positive edge triggered flip-flops. The difference between HD74HC374 and HD74HC534 is only that the former is a true outputs and the latter is a false outputs. Data at the D inputs, meeting the setup and hold time requirements, are transferred to the Q outputs on positive going transitions of the clock (CK) input. When a high logic level is applied to the output control (OC) input, all outputs go to a high impedance state, regardless of what signals are present at the other inputs and the state of the storage elements.

#### **Features**

• High Speed Operation:  $t_{pd}$  (Clock to Q) = 18 ns typ ( $C_L$  = 50 pF)

• High Output Current: Fanout of 15 LSTTL Loads

• Wide Operating Voltage:  $V_{CC} = 2 \text{ to } 6 \text{ V}$ 

• Low Input Current: 1 μA max

• Low Quiescent Supply Current:  $I_{CC}$  (static) = 4  $\mu$ A max (Ta = 25°C)

• Ordering Information

Part Name	Package Type	Package Code (Previous Code)	Package Abbreviation	Taping Abbreviation (Quantity)	
HD74HC374P	DILP-20 pin	PRDP0020AC-B	P		
HD74HC534P	DILP-20 pill	(DP-20NEV)	-	_	
HD74HC374FPEL	SOP-20 pin (JEITA)	PRSP0020DD-B	FP	EL (2.000 pag/roal)	
HD74HC534FPEL	SOF-20 pill (JETTA)	(FP-20DAV)		EL (2,000 pcs/reel)	
HD74HC534RPEL	SOP-20 pin (JEDEC)	PRSP0020DC-A (FP-20DBV)	RP	EL (1,000 pcs/reel)	
HD74HC374TELL	TSSOP-20 pin	PTSP0020JB-A	т	ELL (2,000 pcs/reel)	
HD74HO374TELL	1330F-20 pill	(TTP-20DAV)	'	ELL (2,000 pcs/feet)	

Note: Please consult the sales office for the above package availability.

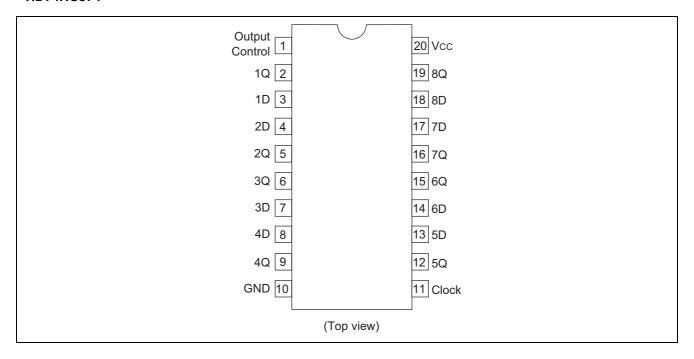
#### **Function Table**

Output Control	Clock	D	HD74HC374 Q	HD74HC534
L		Н	Н	L
L		L	L	Н
L	L	X	No change	No change
Н	X	X	Z	Z

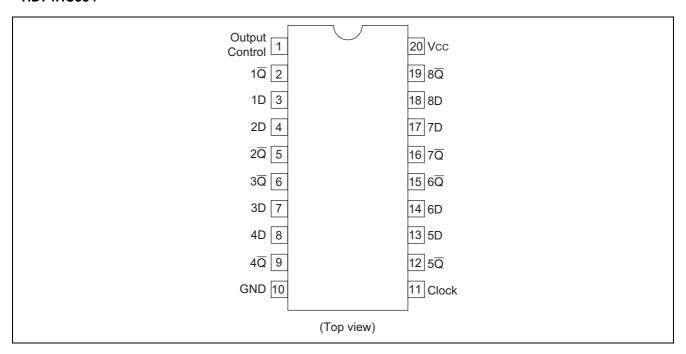
Note: 1. H; High level, L; Low level, X; Irrelevant, Z; High impedance

### **Pin Arrangement**

#### HD74HC374

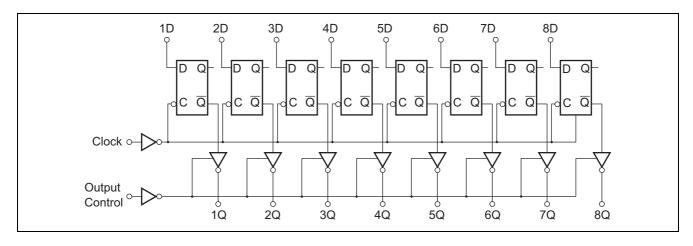


#### HD74HC534

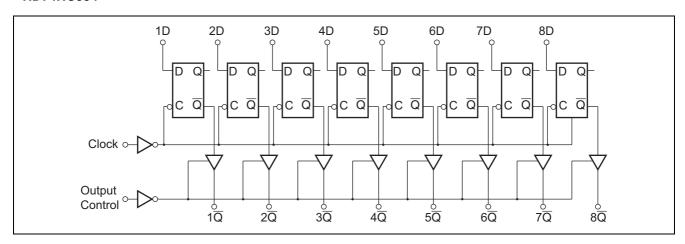


### **Logic Diagram**

#### HD74HC374



#### **HD74HC534**



### **Absolute Maximum Ratings**

Item	Symbol	Ratings	Unit
Supply voltage range	V <sub>CC</sub>	-0.5 to 7.0	V
Input / Output voltage	V <sub>IN</sub> , V <sub>OUT</sub>	−0.5 to V <sub>CC</sub> +0.5	V
Input / Output diode current	I <sub>IK</sub> , I <sub>OK</sub>	±20	mA
Output current	I <sub>оит</sub>	±35	mA
V <sub>CC</sub> , GND current	I <sub>CC</sub> or I <sub>GND</sub>	±75	mA
Power dissipation	P <sub>T</sub>	500	mW
Storage temperature	Tstg	-65 to +150	°C

Note: The absolute maximum ratings are values, which must not individually be exceeded, and furthermore, no two of which may be realized at the same time.

### **Recommended Operating Conditions**

Item	Symbol	Ratings	Unit	Conditions
Supply voltage	V <sub>CC</sub>	2 to 6	V	
Input / Output voltage	V <sub>IN</sub> , V <sub>OUT</sub>	0 to V <sub>CC</sub>	V	
Operating temperature	Та	-40 to 85	°C	
		0 to 1000		$V_{CC} = 2.0 \text{ V}$
Input rise / fall time*1	t <sub>r</sub> , t <sub>f</sub>	0 to 500	ns	V <sub>CC</sub> = 4.5 V
		0 to 400		V <sub>CC</sub> = 6.0 V

Note: 1. This item guarantees maximum limit when one input switches.

Waveform: Refer to test circuit of switching characteristics.

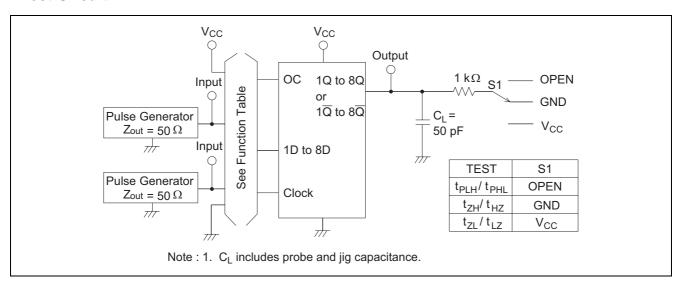
### **Electrical Characteristics**

			Т	a = 25°	С	Ta = -40 to+85°C				
Item	Symbol	V <sub>cc</sub> (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions	
Input voltage	V <sub>IH</sub>	2.0	1.5	_	_	1.5	_	V		
		4.5	3.15	_	_	3.15	_			
		6.0	4.2	_	_	4.2	_			
	$V_{IL}$	2.0	_	_	0.5	_	0.5	V		
		4.5	_	_	1.35	_	1.35			
		6.0	_	_	1.8	_	1.8			
Output voltage	V <sub>OH</sub>	2.0	1.9	2.0	_	1.9	_	V	$Vin = V_{IH} or V_{IL}$	$I_{OH} = -20 \mu A$
		4.5	4.4	4.5	_	4.4	_			
		6.0	5.9	6.0	_	5.9				
		4.5	4.18	_	_	4.13	_			$I_{OH} = -6 \text{ mA}$
		6.0	5.68	_	_	5.63	_			$I_{OH} = -7.8 \text{ mA}$
	V <sub>OL</sub>	2.0	_	0.0	0.1	_	0.1	V	$Vin = V_{IH} or V_{IL}$	$I_{OL} = 20 \mu A$
		4.5		0.0	0.1		0.1			
		6.0		0.0	0.1		0.1			
		4.5	_	_	0.26	_	0.33			$I_{OL} = 6 \text{ mA}$
		6.0	_	_	0.26	_	0.33			$I_{OL} = 7.8 \text{ mA}$
Off-state output	l <sub>OZ</sub>	6.0	_	_	±0.5	_	±5.0	μΑ	$Vin = V_{IH} \text{ or } V_{IL},$	
current									Vout = V <sub>CC</sub> or GND	
Input current	lin	6.0	_	_	±0.1	_	±1.0	μΑ	$Vin = V_{CC}$ or GND	
Quiescent supply current	I <sub>CC</sub>	6.0	_	_	4.0	_	40	μΑ	Vin = $V_{CC}$ or GND, lout = 0 $\mu$ A	

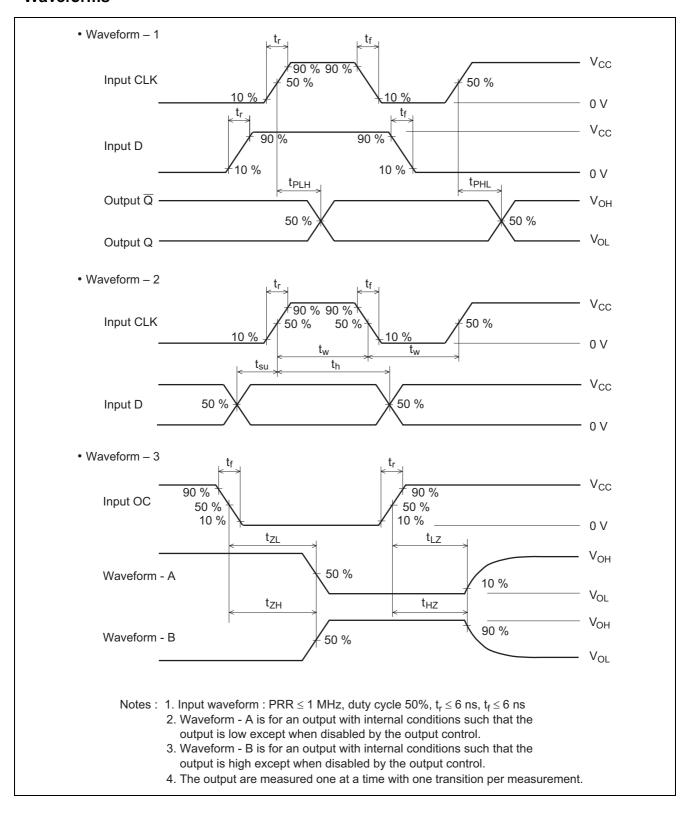
### **Switching Characteristics** ( $C_L = 50 \text{ pF}$ , Input $t_r = t_f = 6 \text{ ns}$ )

			Т	a = 25°	С	Ta = -40	to +85°C		
Item	Symbol	V <sub>CC</sub> (V)	Min	Тур	Max	Min	Max	Unit	Test Conditions
Maximum clock	f <sub>max</sub>	2.0		_	6	_	5	MHz	
frequency		4.5	_	_	30	_	24		
		6.0	_	_	35	_	28		
Propagation delay	t <sub>PHL</sub>	2.0	_	_	140	_	175	ns	
time	$t_{PLH}$	4.5	_	18	28	_	35		
		6.0	_	_	24	_	30		
Output enable	t <sub>ZL</sub>	2.0	_	_	150	_	190	ns	
time		4.5		11	30	_	38		
		6.0		_	26	_	33		
	t <sub>ZH</sub>	2.0		_	150	_	190	ns	
		4.5		14	30	_	38		
		6.0		_	26	_	33		
Output disable	$t_{LZ}$	2.0		_	150	_	190	ns	
time		4.5		13	30	_	38		
		6.0		_	26	_	33		
	t <sub>HZ</sub>	2.0		_	150	_	190	ns	
		4.5	_	16	30	_	38		
		6.0		_	26	_	33		
Setup time	t <sub>su</sub>	2.0	100	_	_	125	_	ns	Data to Clock
		4.5	20	1	_	25	_		
		6.0	17	_	_	21	_		
Hold time	t <sub>h</sub>	2.0	25	_	_	31	_	ns	Clock to Data
		4.5	5	1	_	6	_		
		6.0	5	_	_	6	_		
Pulse width	t <sub>w</sub>	2.0	80	_	_	100	_	ns	Clock or Output control
		4.5	16	6	_	20	_		
		6.0	14	_	_	17	_		
Output rise/fall	t <sub>TLH</sub>	2.0	_	_	60	_	75	ns	
time	t <sub>THL</sub>	4.5	_	4	12	_	15		
		6.0	_	_	10	_	13		
Input capacitance	Cin	_	_	5	10	_	10	pF	

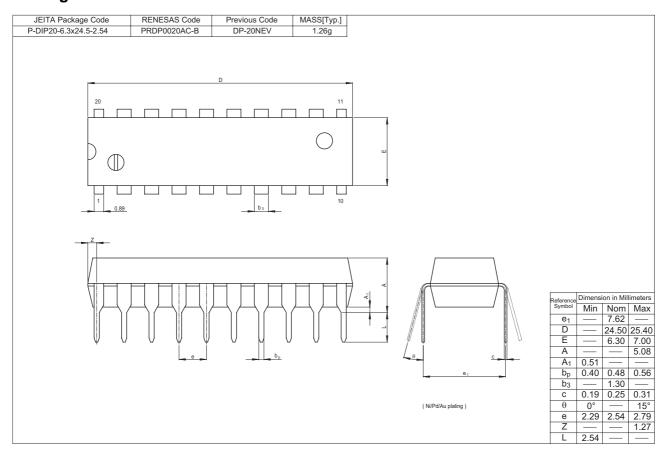
### **Test Circuit**

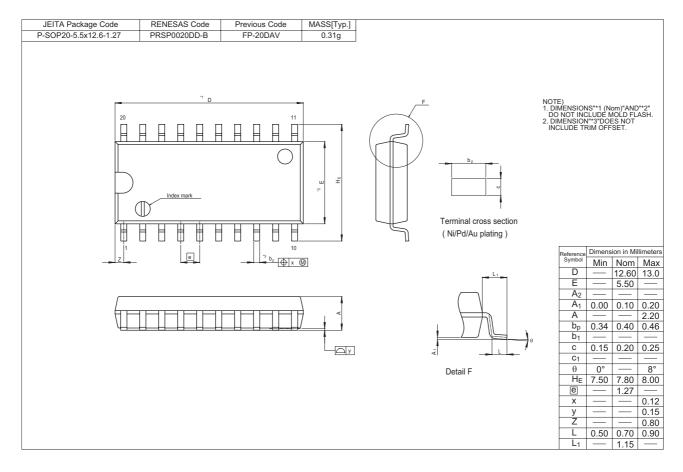


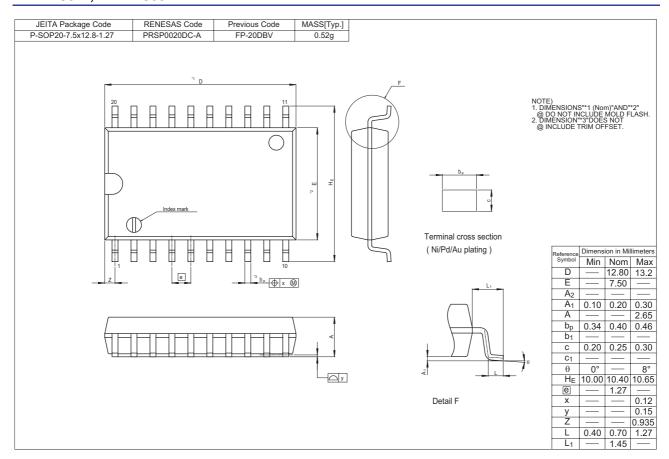
#### **Waveforms**

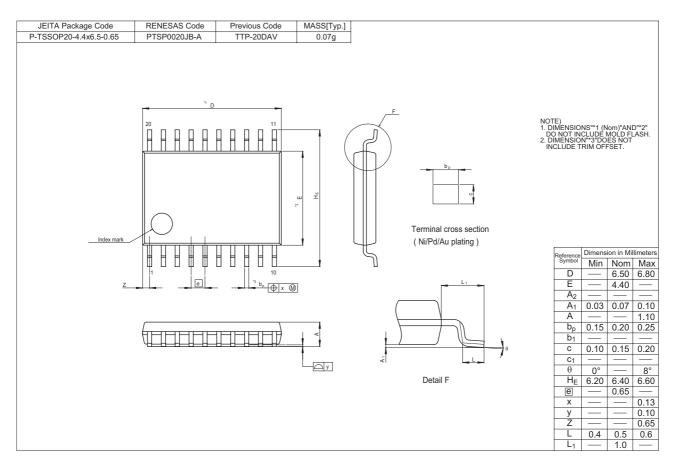


#### **Package Dimensions**









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Renesas Technology Malaysia Sdn. Bhd
Unit 906, Block B, Menara Amcorp, Amcorp Trade Centre, No.18, Jalan Persiaran Barat, 46050 Petaling Jaya, Selangor Darul Ehsan, Malaysia Tel: <603> 7955-9390, Fax: <603> 7955-9510